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Company Name* Response Document ID Company Unique ID Unique ID Authority Response Date* Supplier Comments Supplier Comments Supplier Comments Supplier Comments WHEE Internation of Internation of Internation AND Such information is true AND correct to the best of its knowledge AND belief, as of the date that Intel completes this form. Intel acknowledges that Customer will rely on this certification IN determining the compliance of its products. Customer acknowledges that Intel may have relate on information provided by others Ix Completing this form, AND auch information is true AND correct to the best of its knowledge AND belief, as of the date that Intel completes this form. Intel acknowledges that Customer will rely on this certification IN determining the compliance of its products. Customer acknowledges that Intel may have relate on information provided by others Ix Completing this form, AND and the information in the provided such information. In the lower in the internation is true AND correct to the best of its knowledge AND belief, as of the date that Intel completes this form. Intel acknowledges that Customer will rely on this certification in Noternaming the compliance of its products. Customer acknowledges that Intel may Not Thave independently related by others in the Intel may Not Thave independently related such information. In the wild related the provided provided information provided by others. Intel agreement, its dates and will relate the provided provided information provided by others. Intel agreement, including any warrant in plans AND renductions regarded as part of that agreement, will be the sole AND exclusive source of the intells liability AND the Customers remodels for issues that arise regarding information to his the provided provided information provided by others. Intell agreement, will be the sole and provided by others. Intell agreement will reprove a manufacture of the provided provided as part of the date of the provided provided provided information provided by others.	ubstance Database Version*		JIG-101 Ed. 3.1				
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Supplier Comments This Applies Applies		Company Unique ID	047897855	Contact Phone*	1-800-628-8686		
Supplier Comments Supplier Comments Suppl		Unique ID Authority	Dun and Bradstreet	Contact Email*	rohs@intel.com		
that fine completes this form. Intel acknowledges that Customer acknowledges that Intel may hor have independently reflied an information provided by others IN completing this form, ADI that fuller lamy NOT have independently reflied an information provided by others. Intel agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the partis, AND those certifications are at least one certification in this paragraph. If the Customer ANDI the Intel enter INTO a written agreement with respect to the identified part(s), the terms AND conditions of that agreement, including any warranty rights ANDI the tent enter INTO a written agreement with respect to the identified part(s), the terms AND conditions of that agreement, including any warranty rights ANDI the tent enter INTO a written agreement with respect to the identified part(s), the terms AND conditions of that agreement, including any warranty rights ANDI or remedies of lintel's Standard Terms AND conditions of Sale applicable to such part shall apply. **Product(s)** **Prod		Response Date*	2/26/2013				
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SSDSC2BB080G4xx SSD SSDSC2BB080G4 2/26/2013 66.56 g Single SSD only		_					
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RoHS II per Directive 2011/65/EU of the European

Parliament Product Meets the EU RoHS requirements by application of the selected exemptions

Exemptions 7(a) Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead)

7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound

Low Halogen

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

Signature		
Signature	Intel Product Ecology	

Product Part ID: SSDSC2BBxxxG4xx Product Part Description: SSD

RoHS Substance Group (JIG-101 Ed 3.1)	Description of Use (Reportable Application)	Homogeneous Threshold	Above the threshold? Y/N	Substance Mass% of homogeneous layer	Homogeneous material name	Homogeneous Material Mass% of product part	Exemption	Comments
Cadmium/Cadmium Compounds		0.01 % by weight (100 ppm) of homogeneous materials	No					
Chromium VI Compounds	All	0.1 % by weight (1,000 ppm) of homogeneous materials	No					
Lead/Lead Compounds	All, except as noted in the JIG Substance Group section	0.1 % by weight (1000 ppm) of homogeneous materials	Yes		Pb in glass of resistor and high temp Pb solder in diode	0.0000	7a, 7(c)1	
Mercury/Mercury Compounds		Intentionally added or 0.1 % (1000 ppm) of homogeneous material	No					
Polybrominated Biphenyls (PBBs)	All	0.1 % by weight (1000 ppm) in homogeneous material	No					
Polybrominated Diphenylethers (PBDEs)	All	0.1 % by weight (1000 ppm) in homogeneous material	No					

IG Substance Group	Description of Use	Article Threshold	Above the	Substance Mass% of	Comments
JIG-101 Ed 3.1)	(Reportable Application)		threshold? Y/N	product part	
Asbestos	All	Intentionally added	No		
Azocolourants and azodyes which	Textiles and leather	0.003 % by weight (30 ppm) of the finished			
form certain aromatic amines		textile/leather article	N -		
D	Diagram and a 25 areas and as	0.4.0/ h	No		
Brominated Flame Retardants (other than PBBs, PBDEs or HBCDD)	than in printed wiring board	0.1 % by weight (1000 ppm) of the plastic material			
triali PBBS, PBDES OF HBCDD)	assemblies	material	No		
Brominated Flame Retardants (other		0.09 % total bromine content by weight (900			
than PBBs, PBDEs or HBCDD)	l gilling	ppm) in laminate			
· · · · · · · · · · · · · · · · · · ·		. ,	No		
Cadmium/Cadmium Compounds	Batteries	0.0005 % by weight (5 ppm) of battery			
			No		
Dibutylin (DBT) Compounds	All	0.1% by weight (1000 ppm) of tin in a			
S: . II: (2.27) 6	() = () 1.1.1	material	No		
Dioctyltin (DOT) Compounds	(a) Textiles, (b) childcare	0.1% by weight (1000 ppm) of tin in a			
	articles, (3) RTV-2 moulding kits	material	No		
Fluorinated greenhouse gases (PFC,	All	Intentionally added	110		
SF6, HFC)		internationally added	No		
• •	All	0.1 % by weight (1,000 ppm) of the product	INO		
and all major diastereoisomers	All	0.1 % by weight (1,000 ppin) of the product			
identified			No		
Lead/Lead Compounds	Consumer products designed	0.03% by weight (300 ppm) of children's	140		
zeda, zeda compoditas	or intended primarily for	product			
	children 12 years of age or				
	vounger		No		
Lead/Lead Compounds	Paint and similar surface	0.009 % by weight of surface coating			
	coatings of toys and other				
	articles intended for use by		No		
Lead/Lead Compounds	children Cables/cords with thermoset	0.03 % by weight (300 ppm) of surface	No		
Leady Lead Compounds	or thermoplastic coatings	coating			
	or thermoplastic coatings	County	No		
ead/Lead Compounds	Batteries	0.004 % by weight (40 ppm) of battery	No		
Mercury/Mercury Compounds	Batteries	0.0001% by weight (1 ppm) of battery	No		
Ozone Depleting Substances	All	Intentionally added	No		
Perchlorates	All	0.0000006 % by weight (0.006 ppm) of the			
		product	No		
Perfluorooctane sulfonate (PFOS)	All	Intentionally added	l		
			No		
Select Phthalates Group 1 (BBP,	Children's toys or child care	0.1 % by weight (1000 ppm) of plasticized	No		
DBP, DEHP)	Children's toys or child care	material	INU	-	
	· · · · · · · · · · · · · · · · · · ·				
DINF, DINOP)		material	No		
Selected Phthalates Group 2 (DIDP, DINP, DNOP)	Children's toys or child care article that can be placed in child's mouth	0.1 % by weight (1000 ppm) of plasticized material	No		

Product Part ID:	SSDSC2BBxxxG4xx	Product Part Description:	SSD	
Polychlorinated Biphenyls (PCBs)	All	Intentionally added		
and specific substitutes			No	
Polychlorinated Terphenyls (PCTs)	All	Intentionally added		
			No	
Polychlorinated Naphthalenes (more	All	Intentionally added		
than 3 chlorine atoms)			No	
Polyvinyl Chloride (PVC)	All	0.1 % by weight (1000 ppm) of product	No	
Radioactive Substances	All	Intentionally added	No	
Refractory Ceramic Fibres,	All	0.1% by weight (1000 ppm) of the product		
Aluminosilicate			No	
Refractory Ceramic Fibres, Zirconia	All	0.1% by weight (1000 ppm) of the product		
Aluminosilicate			No	
Shortchain Chlorinated Paraffins	All	0.1 % by weight (1,000 ppm) of product		
(C10 - C13)			No	
Tri-substituted organostannic	All	0.1% by weight (1000 ppm) of tin in a		
compounds		material	No	

REACH Substance List	Reportable Application	Threshold	Above threshold?	Substance Mass% of	Authority	Number	Comments
(JIG-101 Ed 3.1)	neportubie Application	Threshold	Above unesnow.	product part	Authority	Trumber	Comments
(,				p			
Diarsenic pentaoxide	All	0.1 % by weight (1,000 ppm) of the product			CAS	1303-28-2	
·		, , , , , , ,	No				
Diarsenic trioxide	All	0.1 % by weight (1,000 ppm) of the product			CAS	1327-53-3	
			No				
Beryllium oxide (BeO)	All	0.1 % by weight (1000 ppm) of the product	No		CAS	1304-56-9	
Cobalt dichloride	All	0.1% by weight (1000 ppm) of the product	INO		CAS	7646-79-9	
Cobait dichioride	All	0.1% by weight (1000 ppin) of the product	No		CAS	7040-75-5	
Dimethyl fumarate	All	0.00001% by weight (0.1 ppm) in a material			CAS	624-49-7	
,		, , , , , , , , , , , , , , , , , , , ,	No				
Formaldehyde	Composite Wood (plywood,	Intentionally added			CAS	50-00-0	
	particle board, MDF) products						
	or components						
Paramatalah da	Totallor	0.0075.0/ h	No		CAC	F0 00 0	
Formaldehyde	Textiles	0.0075 % by weight (75 ppm) of textile product	No		CAS	50-00-0	
Lead chromate	All	0.1% by weight (1000 ppm) of the product	140		CAS	7758-97-6	
Lead cirromate		o.170 by weight (1000 ppin) of the product	No		Cro	7730 37 0	
Lead chromate molybdate sulfate	All	0.1% by weight (1000 ppm) of the product			CAS	12656-85-8	
red (C.I. Pigment Red 104)							
			No				
Lead sulfochromate yellow (C.I.	All	0.1% by weight (1000 ppm) of the product			CAS	1344-37-2	
Pigment Yellow 34)			No		0.46	7440.00.0	
Nickel	All, where prolonged skin contact is expected	Intentionally added	No		CAS	7440-02-0	
Phenol, 2-(2H-benzotriazol-2-yl)-4,6-		Intentionally added	140		CAS	3846-71-7	
bis(1.1-dimethlethyl)	,	michignany added	No		0.0	50.0717	
Bis (2-ethylhexyl)phthalate (DEHP)	All	0.1 % by weight (1000 ppm) of the product			CAS	117-81-7	
			No				
Dibutyl phthalate (DBP)	All	0.1 % by weight (1000 ppm) of the product			CAS	84-74-2	
			No				
Benzyl butyl phthalate (BBP)	All	0.1 % by weight (1000 ppm) of the product	No		CAS	85-68-7	
Diisobutyl phthalate	All	0.1 % by weight (1000 ppm) of the product	INO		CAS	84-69-5	
Disobutyi pritrialate	All .	0.1 70 by weight (1000 ppin) of the product	No		CAS	04-05-3	
Bis(tributyltin)oxide (TBTO)	All	Intentionally added or 0.1 % by weight (1,000			CAS	56-35-9	
		ppm) of the product	No				
Tris(2-chloroethyl)phosphate	All	0.1 % by weight (1,000 ppm) of the product	_		CAS	115-96-8	
			No				
Tetraboron disodium heptaoxide,	All	0.1 % by weight (1,000 ppm) of the product	No		CAS	12267-73-1	
hydrate Disodium tetraborate, anhydrous	All	0.1 % by weight (1,000 ppm) of the product	No	-	CAS	1303-96-4,	+
Disoulum tetraporate, annydrous	All	0.1 % by weight (1,000 ppin) of the product			CAS	1303-96-4,	
			No			12179-04-3	
Boric Acid	All	0.1 % by weight (1,000 ppm) of the product			CAS	10043-35-3,	
		. 3 (No			11113-50-1	